PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Young-Hun LEE	07/13/2011
Jay-Hyuk SONG	07/13/2011
Ick-Kyu CHOI	07/13/2011
Young-Ki KIM	07/13/2011
Soon-Rewl LEE	07/13/2011
Yu-Mi SONG	07/13/2011
Yoon-Chang KIM	07/13/2011

RECEIVING PARTY DATA

Name:	Samsung SDI Co., Ltd.
Street Address:	428-5 Gongse-dong, Giheung-Gu
City:	Yongin-si, Gyeonggi-do
State/Country:	REPUBLIC OF KOREA

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13184294

CORRESPONDENCE DATA

Fax Number: (949)760-9502

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 9497600404
Email: efiling@kmob.com

Correspondent Name: Knobbe Martens Olson & Bear LLP

Address Line 1: 2040 Main Street Address Line 2: 14th Floor

Address Line 4: Irvine, CALIFORNIA 92614

ATTORNEY DOCKET NUMBER: SDIYPL.384AUS

PATENT

REEL: 026605 FRAME: 0614

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NAME OF SUBMITTER:	Christopher Sweeney
Total Attachments: 3 source=ExecutedAssignment#page1.tif source=ExecutedAssignment#page2.tif source=ExecutedAssignment#page3.tif	

PATENT REEL: 026605 FRAME: 0615 Application No.: Unknown Filing Date: Herewith

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ASSIGNMENT

WHEREAS, I, the undersigned, have invented certain new and useful improvements in an **POSITIVE ACTIVE MATERIAL AND LITHIUM BATTERYINCLUDING THE SAME**, the specification of which was executed on even date herewith.

AND WHEREAS, Samsung SDI Co., Ltd., (hereinafter "ASSIGNEE"), with its principal place of business at 428-5, Gongse-dong, Giheung-gu, Yongin-si, Gyeonggi-do, Republic of Korea, desires to acquire the entire right, title, and interest in and to the said improvements with respect to the United States of America, its territories and possessions.

NOW, THEREFORE, in light of good and valuable consideration, the receipt of which is hereby acknowledged, I, the said inventor, do hereby acknowledge that I have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest throughout the world in, to and under the said improvements, and the said application and all provisional applications relating thereto, and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and I hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

Date:	13/ July / 2011	Signature: LEE. Young -Hun
		Name: LEE, Young-Hun Address: <u>c/o Samsung SDI Co., Ltd.</u>
		428-5, Gongse-dong, Giheung-gu, Yongin-si, Gyeonggi-do, Republic of Korea

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Date:	13/July/2011	Signature: SONG, Jay-Hyuk
		Name: SONG, Jay-Hyuk Address: c/o Samsung SDI Co., Ltd.
		428-5, Gongse-dong, Giheung-gu, Yongin-si, Gyeonggi-do, Republic of Korea
Date:	13/ July / 2011	Signature: CHOL, Ide-Kyu.
		Name: CHOI, Ick-Kyu Address: c/o Samsung SDI Co., Ltd. 428-5, Gongse-dong, Giheung-gu, Yongin-si, Gyeonggi-do, Republic of Korea
Date:	13 / July / 2011	Signature: KIM, Young-Ki Name: KIM, Young-Ki Address: c/o Samsung SDI Co., Ltd.
		428-5, Gongse-dong, Giheung-gu, Yongin-si, Gyeonggi-do, Republic of Korea
Date:	13/ July / 2011	Signature: LEE, Soon-Rewl Name: LEE, Soon-Rewl Address: c/o Samsung SDI Co., Ltd.
		428-5, Gongse-dong, Giheung-gu, Yongin-si, Gyeonggi-do, Republic of Korea

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Date:	13/July/2011	Signature: SONG Yu-Mi
		Name: SONG, Yu-Mi
		Address: <u>c/o Samsung SDI Co., Ltd.</u>
		428-5, Gongse-dong, Giheung-gu,
		Yongin-si, Gyeonggi-do, Republic of Korea
Date:	13/ July / 2011	Signature: KIM, Yoon Chang Name: KIM, Yoon-Chang Address: c/o Samsung SDI Co., Ltd. 428-5, Gongse-dong, Giheung-gu,
		Yongin-si, Gyeonggi-do, Republic of Korea

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